

KB-5252 (ANSI : CEM-1)

覆铜箔无卤环氧纸芯玻璃布复合基层压板

特点

- 无卤板材有利于环境保护
- 优良的冲孔性，最佳冲孔温度为 35℃~60℃
- 良好的耐热性和耐湿性
- 弓曲率、扭曲率小且稳定
- 符合 IPC-4101D/ 15 的规范要求

Features

- Halogen-free, Friendly to the environment.
- Excellent punching property, Suitable for punching at 35℃~60℃
- Excellent heat and humidity resistance.
- Warpage and twist are small and stable.
- IPC-4101D/ 15 specification is applicable.

General Properties 一般特性

Test Item 测试项目	Unit 单位	Test Method (IPC-TM-650) 测试方法	Test Condition 处理条件	Specification (IPC-4101D) 规格值	Typical Value 典型值
Peel Strength (1 oz.) 铜箔剥离强度	N/mm	2.4.8	125℃	--	1.4
			Float 260℃ / 10 Sec	≥1.05	1.4/1.25
Thermal Stress 热应力	Sec	2.4.13.1	Float 260℃/unetched	≥10	25
Bow / Twist 弯弓度/翘曲度	%	2.4.22.1	A	≤ 1.5	0.3 / 0.4
Flexural Strength 抗弯强度	N/mm ²	2.4.4	Length direction	≥242	420
			Cross direction	≥172	290
Flammability 燃烧性	Rating	UL94	UL-94	UL94 V-0	V-0
Surface Resistivity 表面电阻	MΩ	2.5.17.1	C-96/35/90	≥1.0×10 ⁴	1.0×10 ⁵
Volume Resistivity 体积电阻	MΩ-cm	2.5.17.1	C-96/35/90	≥1.0×10 ⁶	1.0×10 ⁷
Z-Axis Expansion Z 轴热膨胀系数	ppm/℃	2.4.24	E-2/105 TMA	---	100 / 320
	%			---	6.0
Dielectric Constant 介电常数	—	2.5.5.2	Etched/@1 MHZ	≤5.4	4.6
Loss Tangent 介质损耗	—	2.5.5.2	Etched/@1 MHZ	≤0.035	0.023
Arc Resistance 耐电弧性	Sec	2.5.1	D-48/50+D-0.5/23	≥60	125
Moisture Absorption 吸水率	%	2.6.2.1	D-24/23	≤0.5	0.2
Comparative Tracking Index 相比漏电起痕指数	V	IEC 60112	Etched/0.1% NH ₄ CL	≥175	175

Remarks: Specimen Thickness: 1.6mm 1/0 样品厚度: 1.6mm 1/0

A = Keep the specimen originally without any process 保持原样, 不作处理

C = Temperature and humidity conditioning 在恒温恒湿的空气中处理

D = Immersing in distilled water with temperature control 浸在恒温的水中处理

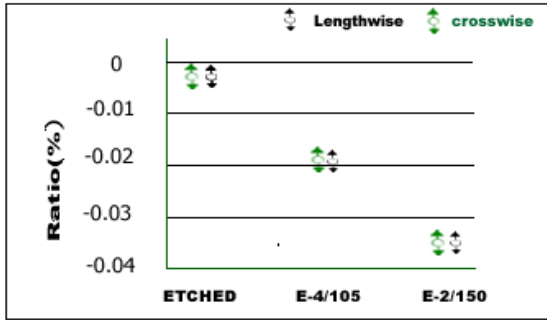
E = Temperature conditioning 在恒温的空气中处理

KB-5252 (ANSI : CEM-1)

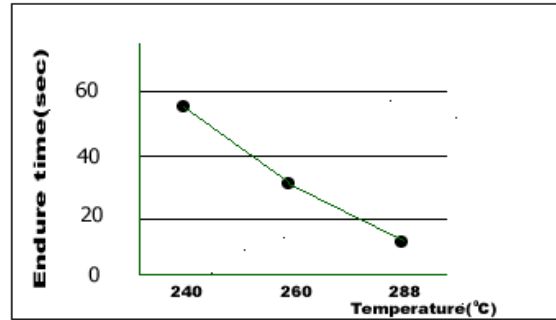
覆铜箔无卤环氧纸芯玻璃布复合基层压板

Speciality Chart 板材特性图

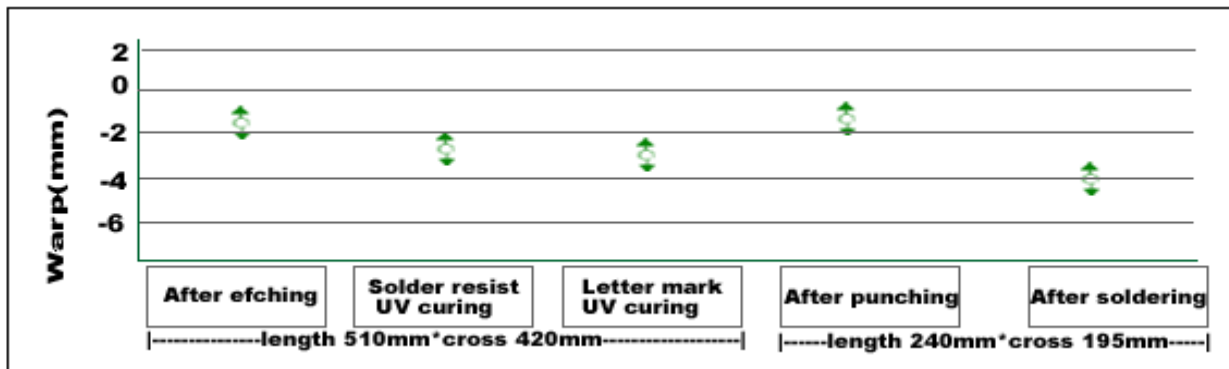
Dimensional stability 尺寸稳定性



Solder Resistance 耐焊性



Warpage through PCB process (thickness 1.6mm single side)



应用领域

- 显示器、录像机、电源基板、工业仪表、数码刻录机等

Applications

- Display, VCR, Power supply, Industrial Instrument, Digital sound recorder, etc.

Purchasing Information 采购信息

Type 类型	Thickness 厚度	Copper Cladding 铜箔厚度	Regular Size (mm) 常规尺寸	CTI Value CTI 值
KB-5252	0.8mm~ 1.6mm	18μm 35μm 70μm	915*1220mm (36"*48") 1020*1220mm (40"*48") 1067*1220mm (42"*48")	175V

Note: Other sheet size and thickness could be available upon request.

可根据客户要求提供其它尺寸和厚度